

High Brightness 5.0×1.75 8 Bar LED Arrays

SBD-85

GENERAL DESCRIPTION

The SBD-85 series of 8 bar light emitting diode arrays has been developed for level meters and other linear display and available in red, orange, green and yellow emitting colors.

The standard units are constructed with black or gray face and milky white segment colors.

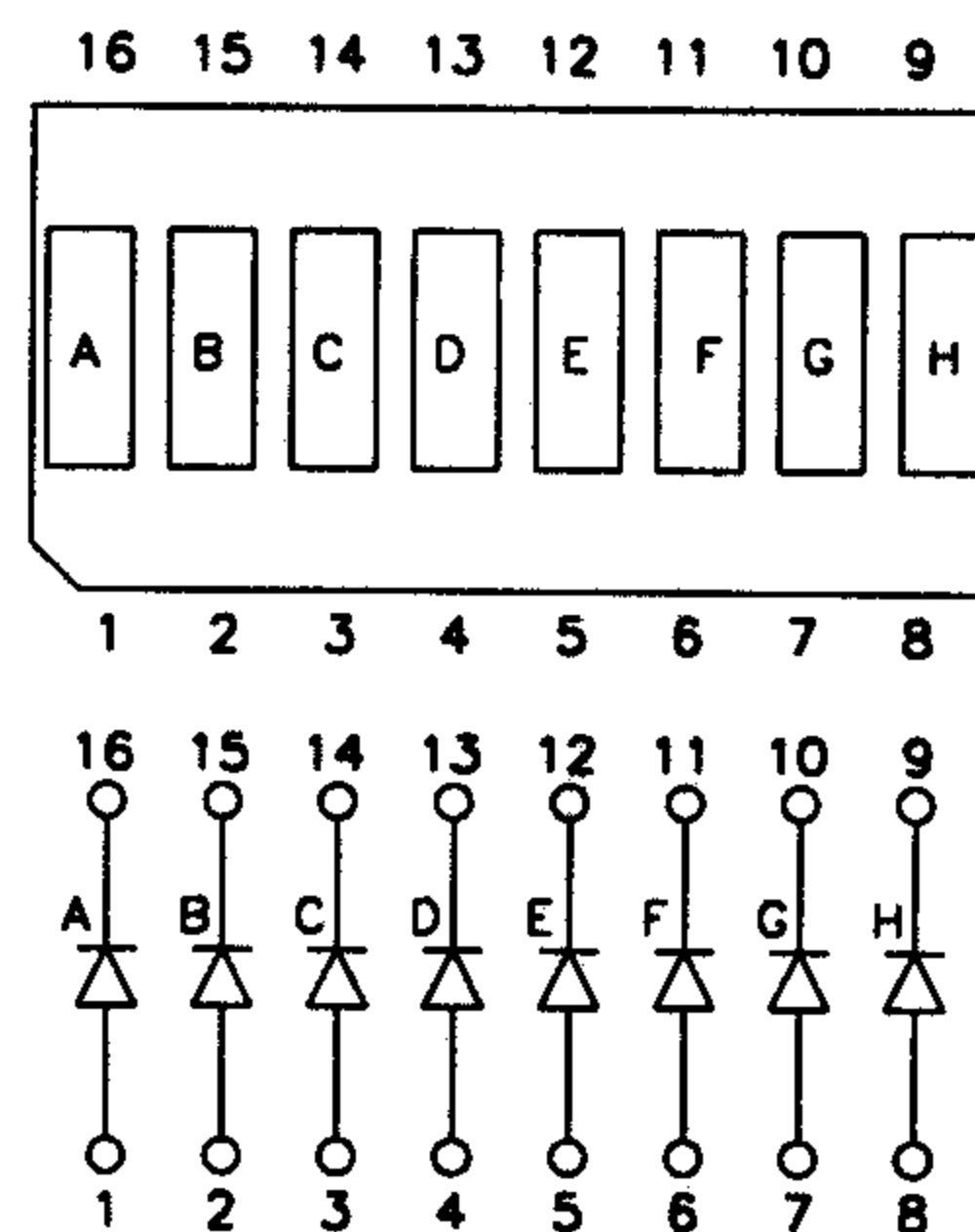
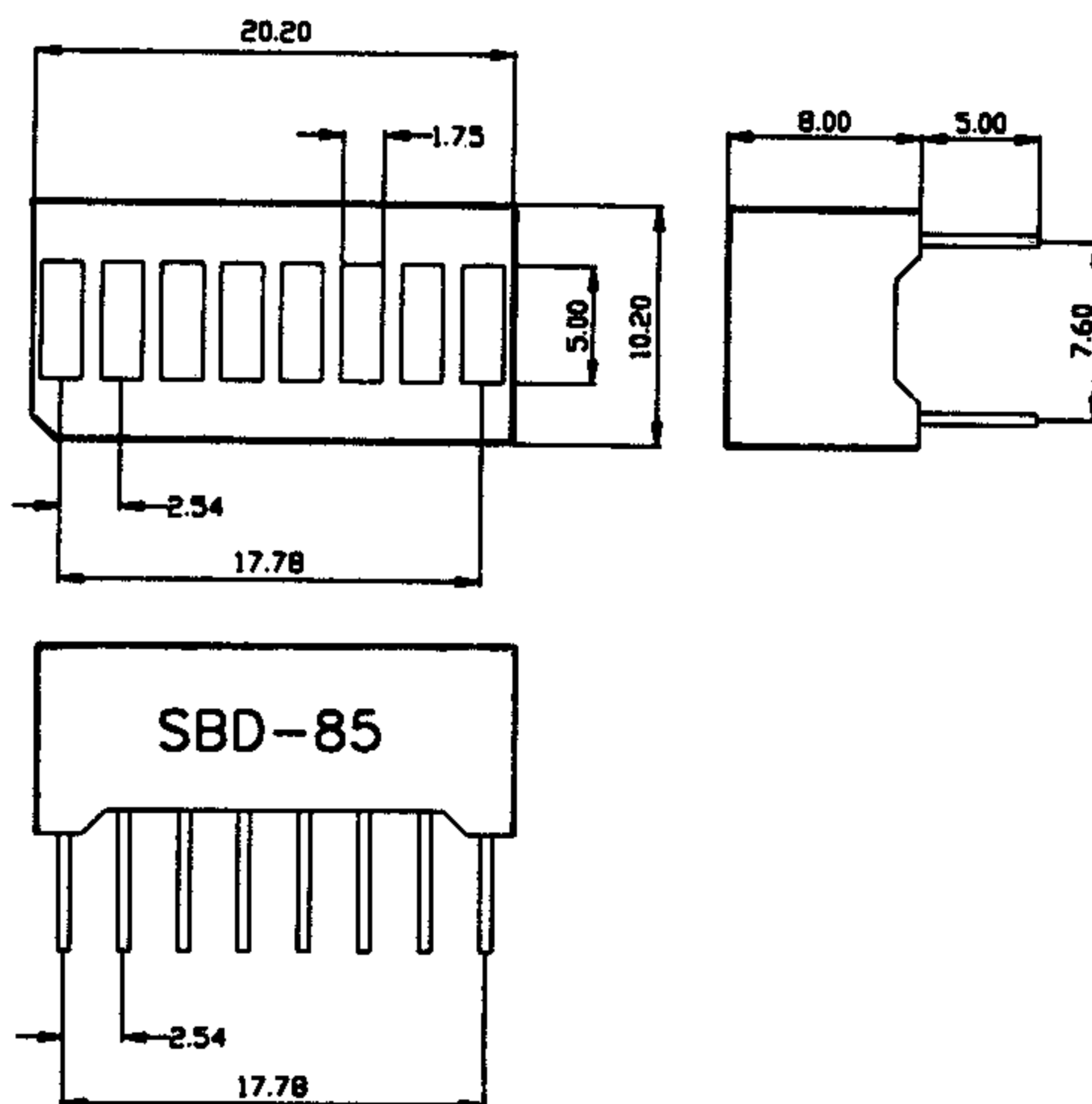
FEATURES

1. High brightness
2. Low power consumption; Directly drive with IC
3. Solid state stability; Long-operation life
4. Could be jointed two or more units
5. Easily identifiable cathode index

Actual size



PACKAGE DIMENSIONS AND CONNECTIONS GUIDE



三光半導体株式会社
SAM KWANG SEMICONDUCTOR CO., LTD.

803 Silla Techno Vil., 39-3 Dang-dong Kunpo-City Kyungki-do, Korea,
 TEL:031-456-1444/1484, FAX:031-456-4224

Red SBD 85R (GaP)

Absolute Maximum Ratings (T_a = 25°C)

Power dissipation/Total	160	mW
Power dissipation/Chip	20	mW
Forward current	20	mA
Peak forward current	60*	mA
Reverse voltage	4	V
Operating temperature	-25 ~ +85	°C
Storage temperature	-55 ~ +100	°C

Green SBD 85G (GaP)

Absolute Maximum Ratings (T_a = 25°C)

Power dissipation/Total	160	mW
Power dissipation/Chip	20	mW
Forward current	20	mA
Peak forward current	60*	mA
Reverse voltage	4	V
Operating temperature	-25 ~ +85	°C
Storage temperature	-55 ~ +100	°C

Orange SBD 85SR (GaAsP/GaP)

Absolute Maximum Ratings (T_a = 25°C)

Power dissipation/Total	160	mW
Power dissipation/Chip	20	mW
Forward current	20	mA
Peak forward current	60*	mA
Reverse voltage	4	V
Operating temperature	-25 ~ +85	°C
Storage temperature	-55 ~ +100	°C

Yellow-green SBD 85UG (GaP)

Absolute Maximum Ratings (T_a = 25°C)

Power dissipation/Total	160	mW
Power dissipation/Chip	20	mW
Forward current	20	mA
Peak forward current	60*	mA
Reverse voltage	4	V
Operating temperature	-25 ~ +85	°C
Storage temperature	-55 ~ +100	°C

Yellow SBD 85Y (GaAsP/GaP)

Absolute Maximum Ratings (T_a = 25°C)

Power dissipation/Total	160	mW
Power dissipation/Chip	20	mW
Forward current	20	mA
Peak forward current	60*	mA
Reverse voltage	4	V
Operating temperature	-25 ~ +85	°C
Storage temperature	-55 ~ +100	°C

Pulse Width 1 ms
Duty Cycle 1/5

Electrical/Optical Characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Min	Typ	Max.	Unit
Forward voltage/Chip	V _F	I _F = 10mA	—	2.1	2.3	V
Reverse current/Chip	I _R	V _R = 4V	—	—	10	μA
Luminous Intensity/Chip	I _V	I _F = 10mA	300	800	—	μcd
Peak wavelength	λ _P	I _F = 10mA	—	700	—	nm
Spectral line halfwidth	Δλ	I _F = 10mA	—	100	—	nm

Electrical/Optical Characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Min	Typ	Max.	Unit
Forward voltage/Chip	V _F	I _F = 10mA	—	2.1	2.3	V
Reverse current/Chip	I _R	V _R = 4V	—	—	10	μA
Luminous Intensity/Chip	I _V	I _F = 10mA	350	900	—	μcd
Peak wavelength	λ _P	I _F = 10mA	—	555	—	nm
Spectral line halfwidth	Δλ	I _F = 10mA	—	30	—	nm

Electrical/Optical Characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Min	Typ	Max.	Unit
Forward voltage/Chip	V _F	I _F = 10mA	—	2.0	2.2	V
Reverse current/Chip	I _R	V _R = 4V	—	—	10	μA
Luminous Intensity/Chip	I _V	I _F = 10mA	700	1500	—	μcd
Peak wavelength	λ _P	I _F = 10mA	—	635	—	nm
Spectral line halfwidth	Δλ	I _F = 10mA	—	35	—	nm

Electrical/Optical Characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Min	Typ	Max.	Unit
Forward voltage/Chip	V _F	I _F = 10mA	—	2.1	2.3	V
Reverse current/Chip	I _R	V _R = 4V	—	—	10	μA
Luminous Intensity/Chip	I _V	I _F = 10mA	600	1200	—	μcd
Peak wavelength	λ _P	I _F = 10mA	—	565	—	nm
Spectral line halfwidth	Δλ	I _F = 10mA	—	30	—	nm

Electrical/Optical Characteristics (T_a = 25°C)

Parameter	Symbol	Conditions	Min	Typ	Max.	Unit
Forward voltage/Chip	V _F	I _F = 10mA	—	2.0	2.2	V
Reverse current/Chip	I _R	V _R = 4V	—	—	10	μA
Luminous intensity/Chip	I _V	I _F = 10mA	600	1000	—	μcd
Peak wavelength	λ _P	I _F = 10mA	—	585	—	nm
Spectral line halfwidth	Δλ	I _F = 10mA	—	30	—	nm